## Veloxity <sup>™</sup> 200

## **Board Specifications**

FPGA	<ul> <li>AMD Xilinx Virtex Ultrascale Plus XCVU13PFHGA2014-2L-E</li> <li>Speed Grade -2, Low Power</li> <li>Extended temperature range</li> </ul>
On-board Flash	2Gbit Flash memory for booting FPGA
DRAM	<ul><li>2x DDR4 DIMM Slots (256GB Total, 2x 128GB)</li><li>2400MHz</li></ul>
Host interface	<ul> <li>PCle Gen3 x 16 interface direct to FPGA, connected PCl-e hard IP</li> </ul>
QSFP28 cage	<ul> <li>400 Gbps (8x 50 Gbps PAM4)</li> <li>PAM4: 2x 200GbE, 4x 100GbE, 8x 50GbE</li> <li>NRZ: 2x 200GbE, 4x 100GbE, 8x 50GbE, 16x 10/25 GbE</li> <li>Multi-rate hard MAC supports all combinations</li> </ul>
NVME	1x M.2 NVMe Connector
SlimSAS	2x SlimSAS, 2x 200Gbps Connectors
External Power Pin	<ul> <li>1 PCle Slot (75W)</li> <li>2 8-Pin connectors (up to 150W each, 300W Total)</li> </ul>
VCCINT Supply	• 200 A
Config Port	PMBus, Soft Processor JTAG

SD Card	<ul><li>Boot drive for soft core processor</li><li>Data storage expansion</li></ul>
Cooling	Standard: single-width passive heat- sink
Electrical	<ul> <li>PCle slot (75W), 2x 8-pin External PCle 12V connectors (2x 150W)</li> <li>Up to 375W total</li> </ul>
Environmental	• Operating Temperature: 0°C - 100°C
Quality	<ul> <li>Manufactored to IPC-A-610</li> <li>Class 2</li> <li>RoHS compliant</li> <li>CE, FCC, UKCA &amp; ICES approvals</li> </ul>
Form factor	<ul> <li>Full height, 3/4 length PCle double-slot board</li> <li>Size: 111.15 mm x 252 mm</li> <li>(4.37 in x 10 in)</li> </ul>

## **Development Tools**

System development	<ul> <li>Pascaline SDK including PCl-e driver, Host software, libraries, and board utilities</li> </ul>
Application	<ul> <li>C High level synthesis, AMD Vivado</li></ul>
development	Tools (HDL and VHDL)

To learn more, visit

www.pascalinetechnology.com

Rev 2024.011.01 Nov 2024

